



PLACEMENT AND INTERNSHIP EXPERIENCES

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COMPANY REQUIREMENTS

ELIGIBLE BRANCHES

EEE **CSE ECE** **CG CUTOFF**

7.0 cgpa of B.Tech

SELECTION PROCEDURE

1 online test and one technical interview for internship



INTERN EXPERIENCE TALK

BRACH: - Electrical and Electronics Engineering

INTERNSHIP SEASON:- FTE

DESCRIPTION OF ROLE: - Associate hardware engineer

Designing the layouts of printed circuit boards and also to Design and validate various products like power management IC on a PCB

INTERN LOCATION :- Hyderabad

SKILLS LEARNED:-



DESCRIPTION OF ONLINE TEST:-

Online test it has 3 sections each 30min, these 4 sections includes Aptitude, C++ and Python and the domain knowledge of the role you have applied for. I have got the hardware part like power electronics, digital electronics, analog and some electrical circuits



DESCRIPTION OF INTERVIEW:-

For me it was mostly resume based, and as my resume had a project on power electronics, the interviewer mostly asked about power electronics in depth. I don't remember the exact questions. But It was totally on power electronics.

HR was included in technical and they asked what are your future goals. Where do you see yourself In 5 years and what exactly are you interested in.

Effective way to prepare can be consistent practice and solve many questions, solve gate questions if you are preparing for core side placements and make notes of important subjects mainly electronics part as the basics will be needed more to solve the questions in interviews.